

ALPHA-TOP TECHNOLOGY CORP.

APPROVAL SHEET

MODEL NO.:	nSMD016-30V	
CUSTOMER:		
CUSTOMER'S APPRO	VAL:	
AUTHORIZED SIGNAT	URE/STAMP:	
DATE		
DATE		

MANUFACTURER:	
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Submitted by: Approved by: DATE:	Chen YC Lin 21-Dec-21

SEA & LAND ELECTRONIC CORP.

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Features Surface Mount Devices

- Lead free device
- Size 3.2*1.6 mm/0.12*0.06 inch
- Surface Mount packaging for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 60V and a load to be protected, including: Computer mother board, Modem. USB hub PDAs & Charger, Analog & digital line card Digital cameras, Disk drivers, CD-ROMs,

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Alpha-Top (Sea&Land Alliance)

nSMD016-30V

erformance Specification		V _{max} I _r	I _{max}	I _{hold}	I _{trip}	P _d	Maximum Time To Trip		Resistance		Agency Approval	
Model	Marking	(Vdc)	(A)	@25°C (A)	@25°C (A)	Max. (W)	Current (A)	Time (Sec)	Ri _{min} (Ω)	R1max (Ω)	UL	TUV
nSMD016-30V	αD	30.0	100	0.16	0.37	0.6	1.00	0.30	1.200	5.000		
Instructore-solv ab 30.0 100 0.16 0.37 0.6 1.00 0.30 1.200 5.000 Ihold = Hold Current. Maximum current device will not trip in 25°C still air. Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air. Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax). Imax = Maximum fault current device is in the tripped state in 25°C still air environment at rated voltage. Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C. R1 _{max} = Maximum device resistance is measured one hour post reflow. CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.												

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions :	- 40 °C to 85 °C	
Maximum surface temperature of the de	evice in the tripped state is 125 °C	

Agency Approvals :

Regulation/Standard:



2015/863/EU

EN14582

Ihold Versus Temperature

Model		Max	timum ambie	ent operating	temperature	e (T _{mao}) vs. h	old current (I _{hold})	
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
nSMD016-30V	0.236	0.210	0.185	0.160	0.136	0.120	0.112	0.096	0.088

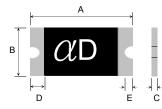


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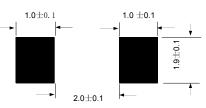
Construction And Dimension (Unit:mm)								
Model A B C D								E
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
nSMD016-30V	3.00	3.50	1.50	1.80	0.60	1.10	0.15	0.10

Dimensions & Marking



 α = Trademark N = Part identification

Recommended Pad Layout (mm)



Termination Pad Characteristics

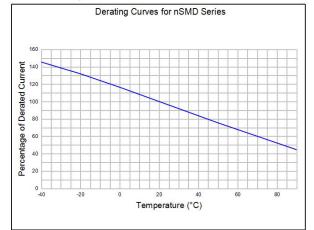
Terminal pad materials : Terminal pad solderability :

Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

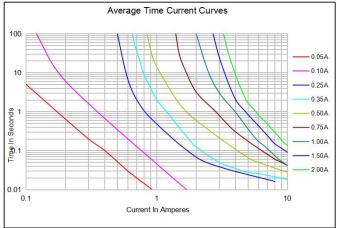
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



WARNING:

Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

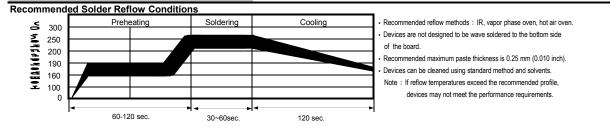
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated. Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

Device performance can be impacted negatively in devices are nanuacia in a manner inconsistent with recommended electronic, inermai, and mechanical procedures for electronic components.
 Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
 Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
 Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
 Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

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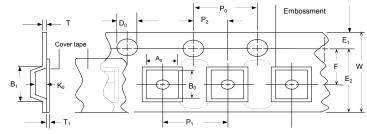
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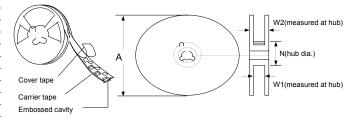
Tape And Reel Specifications (mm)

$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Governing Specifications	EIA 481-1
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	W	8.15 ± 0.3
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	P0	4.0 ± 0.10
$\begin{tabular}{ c c c c c c c } \hline A0 & 1.95 \pm 0.10 \\ \hline B0 & 3.45 \pm 0.10 \\ \hline B1 max. & 4.35 \\ \hline D0 & 1.5 \pm 0.1, -0 \\ \hline F & 3.5 \pm 0.05 \\ \hline E1 & 1.75 \pm 0.10 \\ \hline E2min. & 6.25 \\ \hline Tmax. & 0.6 \\ \hline T1max. & 0.1 \\ \hline K0 & 1.04 \pm 0.1 \\ \hline Leader min. & 390 \\ \hline Trailer min. & 160 \\ \hline Reel Dimensions \\ \hline A max. & 178 \\ \hline N min. & 60 \\ \hline W1 & 9 \pm 0.5 \\ \hline \end{tabular}$	P1	4.0 ± 0.10
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	P2	2.0 ± 0.05
B1max. 4.35 D0 1.5 + 0.1, -0 F 3.5 ± 0.05 E1 1.75 ± 0.10 E2min. 6.25 Tmax. 0.6 T1max. 0.1 K0 1.04 ± 0.1 Leader min. 3990 Trailer min. 160 Reel Dimensions 178 N min. 60 W1 9 ± 0.5	_A0	1.95 ± 0.10
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	<u>B0</u>	3.45 ± 0.10
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	B1max.	4.35
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	D0	1.5 + 0.1, -0
E2min. 6.25 Tmax. 0.6 T1max. 0.1 K0 1.04 ± 0.1 Leader min. 390 Trailer min. 160 Reel Dimensions 1 A max. 178 N min. 60 W1 9 ± 0.5	F	3.5 ± 0.05
Tmax. 0.6 T1max. 0.1 K0 1.04 ± 0.1 Leader min. 390 Trailer min. 160 Reel Dimensions A A max. 178 N min. 60 W1 9 ± 0.5	_E1	1.75 ± 0.10
T1max. 0.1 K0 1.04 ± 0.1 Leader min. 390 Trailer min. 160 Reel Dimensions 100 N min. 60 W1 9 ± 0.5	E2min.	6.25
K0 1.04 ± 0.1 Leader min. 390 Trailer min. 160 Reel Dimensions 178 A max. 178 N min. 60 W1 9 ± 0.5	Tmax.	0.6
Leader min. 390 Trailer min. 160 Reel Dimensions 178 A max. 178 N min. 60 W1 9±0.5	T1max.	0.1
Trailer min. 160 Reel Dimensions	<u>K0</u>	1.04 ± 0.1
Reel Dimensions A max. 178 N min. 60 W1 9±0.5	Leader min.	390
A max. 178 N min. 60 W1 9±0.5	Trailer min.	160
N min. 60 W1 9±0.5	Reel Dimensions	
W1 9±0.5	A max.	178
	N min.	60
W2 12.6 ± 0.5	W1	9 ± 0.5
	W2	12.6 ± 0.5

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

• Storage conditions : 40°C max, 70% R.H.

• Devices may not meet specified performance if storage conditions are exceeded.

 Order Information
 Packaging

 nSMD
 016
 Tape & Reel Quantity

 Product name
 Hold
 3,500 pcs/reel

 Size 3216 mm / 1206 inch
 Current
 3,500 pcs/reel

 SMD : surface mount device
 0.16A
 3,500 pcs/reel

Tape & reel packaging per EIA481-1

Labeling Information

